# 2SC4805

## Silicon NPN epitaxial planar type

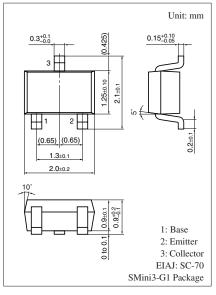
### For 2 GHz band low-noise amplification

### ■ Features

- High transition frequency f<sub>T</sub>
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing

## ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	15	V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	10	V
Emitter-base voltage (Collector open)	$V_{EBO}$	2	V
Collector current	$I_C$	65	mA
Collector power dissipation	P <sub>C</sub>	150	mW
Junction temperature	$T_{j}$	150	°C
Storage temperature	$T_{stg}$	-55 to +150	°C



Marking Symbol: 3S

## $\blacksquare$ Electrical Characteristics $T_a = 25 ^{\circ}C \pm 3 ^{\circ}C$

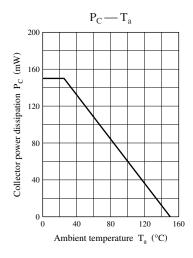
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 10 \text{ V}, I_{E} = 0$			1	μΑ
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	$V_{EB} = 1 \text{ V}, I_C = 0$			1	μΑ
Forward current transfer ratio *	$h_{FE}$	$V_{CE} = 8 \text{ V}, I_{C} = 20 \text{ mA}$	50		300	_
Transition frequency	$f_T$	$V_{CE} = 8 \text{ V}, I_{C} = 15 \text{ mA}, f = 1.5 \text{ GHz}$	7.0	8.5		GHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$		0.6	1.0	pF
(Common base, input open circuited)						
Forward transfer gain	S <sub>21e</sub>   2	$V_{CE} = 8 \text{ V}, I_{C} = 15 \text{ mA}, f = 1.5 \text{ GHz}$	7	9		dB
Maximum unilateral power gain	$G_{UM}$	$V_{CE} = 8 \text{ V}, I_{C} = 15 \text{ mA}, f = 1.5 \text{ GHz}$		10		dB
Noise figure	NF	V <sub>CE</sub> = 8 V, I <sub>C</sub> = 7 mA, f = 1.5 GHz		2.2	3.0	dB

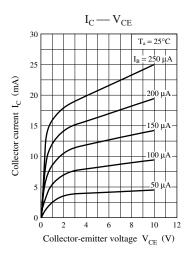
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

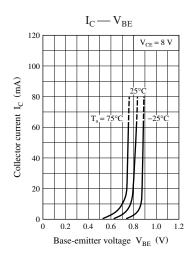
#### 2. \*: Rank classification

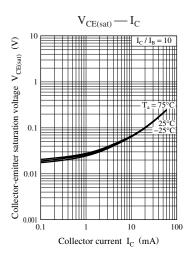
Rank	Q	R	S	No-rank
$h_{FE}$	50 to 120	100 to 170	150 to 300	50 to 300
Marking symbol	3SQ	3SR	3SS	3S

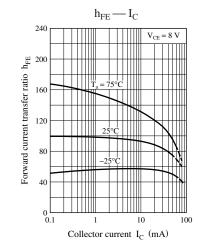
Product of no-rank is not classified and have no indication for rank.

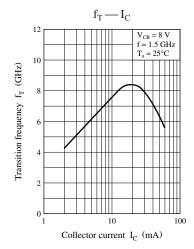


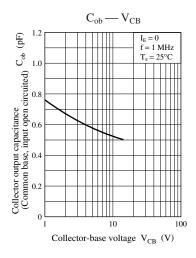


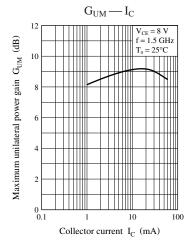


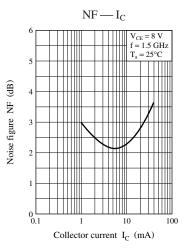












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